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PTO/SB/21 (6-98) (modified)  
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Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

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B.M.

<b>TRANSMITTAL FORM</b>  (to be used for all correspondence after initial filing)	Application Number	10/047,982	
	Filing Date	1/14/02	
	First Named Inventor	Steve Teig	
	Group Art Unit	<none yet>	
	Examiner Name	<none yet>	
Total Number of Pages in This Submission	*	Attorney Docket Number	SPLX.P0053

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SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT	
Firm Or Individual name	Mani Adeli, Reg. No. 39,585 of Stattler Johansen & Adeli LLP
Signature	
Date	April 23, 2003

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This Information Disclosure Statement under 37 C.F.R. § 1.97 is not to be construed as a representation that: (i) a complete search has been made; (ii) additional information material to the examination of this application does not exist; (iii) the information, protocols, results and the like reported by third parties are accurate or enabling; or (iv) the above information constitutes prior art to the subject invention.

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Dated: April 23, 2003

Respectfully submitted,

By: \_\_\_\_\_

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PATENT  
Docket No. SPLX.P0053

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In the application of:

Steve Teig

Serial No.: 10/047,982

Filing Date: 1/14/02

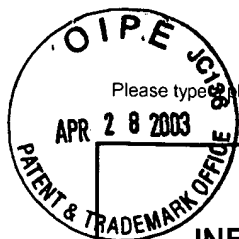
For: METHOD AND APPARATUS FOR  
PROBABILISTIC ROUTING

INFORMATION DISCLOSURE  
STATEMENT UNDER 37 C.F.R. § 1.97

Assistant Commissioner for Patents  
Washington, D.C. 20231

Dear Sir:

Pursuant to 37 C.F.R. § 1.97 and § 1.98, applicants submit for consideration in the above-identified application the documents listed on the attached Form PTO-1449. Copies of the documents are also submitted herewith. The Examiner is requested to make these documents of record. Applicants would appreciate the Examiner initialing and returning the Form PTO-1449, indicating that the information has been considered and made of record herein.



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<b>Substitute for form 1449A/PTO</b>  <b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b>  (use as many sheets as necessary)				<b>Application Number</b>	10/047,982
				<b>Filing Date</b>	1/14/02
				<b>First Named Inventor</b>	Steve Teig
				<b>Group Art Unit</b>	
				<b>Examiner Name</b>	
<b>Sheet</b>	1	of	1	<b>Attorney Docket Number</b>	SPLX.P0053

U.S. PATENT DOCUMENTS						
Examiner* Initials	Cite No. <sup>1</sup>	U.S. Patent Document Number	Kind Code <sup>2</sup> (if known)	Name of Patentee or Applicant of Cited Document	Date of Publication MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
	1.	2001/ 0003843	A1	Scepanovic et al.	06-14-01	
	2.	4,615,011		Linsker	09-30-86	
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	4.	4,782,193		Linsker	11-01-88	
	5.	4,855,929		Nakajima	08-08-89	
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	24.	5,859,449		Kobayashi et al.	01-12-99	
	25.	5,898,597		Scepanovic et al.	04-27-99	

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<b>Sheet</b>	3	<b>of</b>	3	<b>Attorney Docket Number</b>	SPLX.P0053

U.S. PATENT DOCUMENTS						
	53.	6,516,455	B1	Teig et al.	02-04-03	
	54.	2003/0025 205	A1	Shively	02-06-03	

FOREIGN PATENT DOCUMENTS								
Examiner* Initials	Cite No. <sup>1</sup>	Foreign Patent Document			Name of Patentee or Applicant of Cited Document	Date of Publication MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T <sup>6</sup>
		Office <sup>3</sup>	Number <sup>4</sup>	Kind Code (if known) <sup>5</sup>				
	55.	JP	64-15947		Ouchi	01-19-89		
	56.	JP	04000677		Fujiwara et al.	01-1992		

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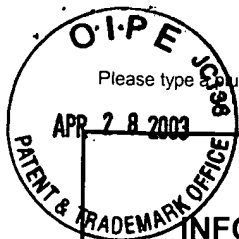
### OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS

Examiner* Initials	Cite No. <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T <sup>6</sup>
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<b>Sheet</b>	5	of	5	<b>Attorney Docket Number</b>	SPLX.P0053

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